

Features & Benefits

- Adhesion to a wide variety of substrates
- Full cure at room temperature
- Easy to apply
- Self-levelling
- Ideal for electronic potting & encapsulation applications

Description

PERMABOND® MT382 two-part, modified epoxy adhesive designed for sealing/bonding and potting applications. It has excellent adhesion to Nylon, ABS, Polycarbonate and other plastics as well as a variety of different metals. The product can be cured in different mix ratios depending on the flexibility required in the final cured product. MT382 is self-levelling.

Physical Properties of Uncured Adhesive

	MT382A	MT382B
Chemical composition	Epoxy Resin	Polyamine based Hardener
Appearance	Black	Yellow
Mixed appearance	Charcoal black	
Viscosity @ 25°C	32,000 mPa.s (cP)	300 mPa.s (cP)
Specific gravity	1.3	1.0

Typical Curing Properties

Mix ratio	2:1 by volume 130:50 by weight
Maximum gap fill	0.5 mm <i>0.02 in</i>
Usable / pot life @25°C	20-50 mins
Handling time to 0.1 N/mm ² @25°C	105-120 mins
Full cure @25°C	≥72 hours

Electrical Properties*

Dielectric Constant	6
Dielectric Strength	20 - 30 kV/ mm
Volume Resistivity	1 - 3 x 10 ¹¹ Ohm-cm

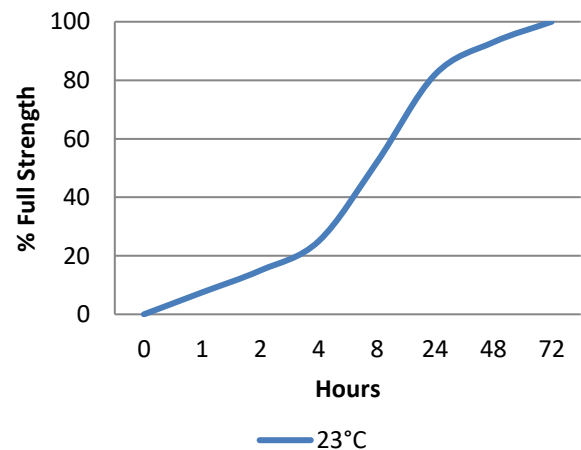
*Asterisk denotes values considered typical to associated resin systems or extrapolated from other test results.

Typical Performance of Cured Adhesive

Shear strength ISO4587	Mild steel: 4-7 N/mm ² (600 - 1000psi) Aluminium: 6-8 N/mm ² (900-1200psi) ABS: 4-6 N/mm ² (600-900psi) Acrylic: 2-5 N/mm ² (300-700psi) Nylon: 2-4 N/mm ² (300-600psi) Polycarbonate: 4-6 N/mm ² (600-900psi) PVC: 3-5 N/mm ² (400-700psi) FRP Glass Epoxy: 5-7 N/mm ² (700-1000psi) FRP Glass Polyester: 5-7 N/mm ² (700-1000psi) Carbon Fibre: 6-8 N/mm ² (600-1200psi)
Hardness (ISO868)	55-85 Shore A 20-30 Shore D
Elongation at break (ISO37)	150 -200%
Peel strength (aluminium) (ISO4578)	140-160 N/25mm (31-36 PIW)
Thermal conductivity	0.47 W/(m.K)
Linear Coefficient of Thermal Expansion	112 x 10 ⁻⁶ m/m C (below Tg) 170 x 10 ⁻⁶ m/m C (above Tg)
Tg	-35°C (-31°F)

*Strength results will vary depending on the level of surface preparation and gap.

Strength Development

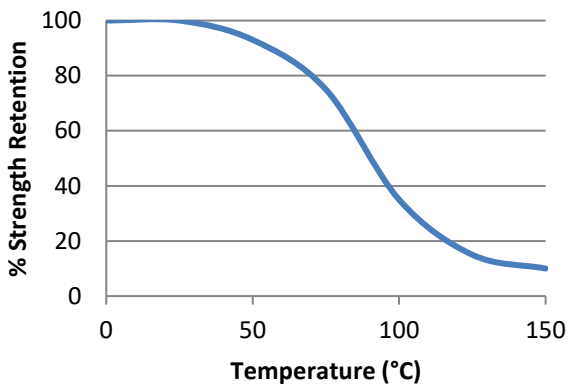


Graph shows typical strength development of bonded components at 23°C. Curing at higher or lower temperatures may affect cure speed.

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Hot Strength



"Hot strength" shear strength tests performed on mild steel. Fully cured specimens conditioned to pull temperature for 30 minutes before testing at temperature.

MT382 can withstand higher temperatures for brief periods (such as for paint baking and wave soldering processes) providing the joint is not unduly stressed. The minimum temperature the cured adhesive can be exposed to is -40°C (-40°F) depending on the materials being bonded.

Additional Information

This product is not recommended for use in contact with strong oxidizing materials.

Information regarding the safe handling of this material may be obtained from the safety data sheet.

Users are reminded that all materials, whether innocuous or not, should be handled in accordance with the principles of good industrial hygiene.

This Technical Datasheet (TDS) offers guideline information and does not constitute a specification.

Surface Preparation

Surfaces should be clean, dry and grease-free before applying the adhesive. Use a suitable solvent (such as acetone or isopropanol) for the degreasing of surfaces. Some metals such as aluminium, copper and its alloys will benefit from light abrasion with emery cloth (or similar), to remove the oxide layer.

Directions for Use

1. Measure volumetrically 2 parts resin to 1 part hardener. Mix thoroughly taking care not to entrap air. Adhesive can be applied and mixed by automated dispensing equipment. If using cartridges, put cartridge in dispensing gun and affix static mixing nozzle.
2. Apply material. If potting; take care to fill component and not entrap air.
3. If bonding a joint, assemble the parts. Parts must be joined within 20-50 minutes of mixing the two epoxy components.
4. Large quantities and/or higher temperature will decrease the usable life or pot life.
5. Apply pressure to the assembly by clamping for 105-120 minutes or until handling strength is obtained.
6. Full cure will be obtained after a **minimum of 72** hours at 25°C (77°F). Heat can be used to accelerate the curing process.

NB. Exercise caution when mixing large quantities due to exothermic reaction.

Video Links

Surface preparation:

<https://youtu.be/8CMOMP7hXjU>



Two-part epoxy directions for use:

<https://youtu.be/GRX1RyknYqc>



Storage & Handling

Storage Temperature	5 to 25°C (41 to 77°F)
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www.permabond.com

- UK: 0800 975 9800
- General Enquiries: +44 (0)1962 711661
- US: 732-868-1372
- Asia: + 86 21 5773 4913

info.europe@permabond.com

info.americas@permabond.com

info.asia@permabond.com

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